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74LVT16374 • 74LVTH16374 Low Voltage 16-Bit D-Type Flip-Flop with 3-STATE Outputs

General Description

Features

- Input and output interface capability to systems at $5V V_{CC}$
- Bushold data inputs eliminate the need for external pull-up resistors to hold unused inputs (74LVTH16374), also available without bushold feature (74LVT16374)
- Live insertion/extraction permitted
- Power Up/Power Down high impedance provides glitch-free bus loading
- Outputs source/sink –32 mA/+64 mA
- Functionally compatible with the 74 series 16374
- Latch-up performance exceeds 500 mA
- ESD performance: Human-body model > 2000V Machine model > 200V
 - Charged-device model > 1000V
- Also packaged in plastic Fine-Pitch Ball Grid Array (FBGA)

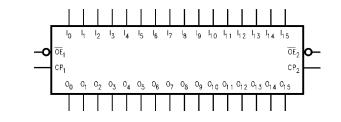
Ordering Code:

FAIRCHII SEMICONDUC 74LVT1637	TOR™ 74 • 74LV		January 1999 Revised June 2005	74LVT16374 •	
Low Voltag		•••	ip-Flop	74LVTI	
General Desc	•		Features ■ Input and output interface capability to systems at	116	
The LVT16374 and LVTH16374 contain sixteen non-inverting D-type flip-flops with 3-STATE outputs and is intended for bus oriented applications. The device is byte controlled. A buffered clock (CP) and Output Enable (\overline{OE}) are common to each byte and can be shorted together for full 16-bit operation. The LVTH16374 data inputs include bushold, eliminating the need for external pull-up resistors to hold unused inputs. These flip-flops are designed for low-voltage (3.3V) V _{CC} applications, but with the capability to provide a TTL interface to a 5V environment. The LVT16374 and LVTH16374 are fabricated with an advanced BiCMOS technology to achieve high speed operation similar to 5V ABT while maintaining a low power dissipation.			 a high and soluble minimum of apaising to systems at 5V V_{CC} Bushold data inputs eliminate the need for external pull-up resistors to hold unused inputs (74LVTH16374), also available without bushold feature (74LVT16374) Live insertion/extraction permitted Power Up/Power Down high impedance provides glitch-free bus loading Outputs source/sink -32 mA/+64 mA Functionally compatible with the 74 series 16374 Latch-up performance exceeds 500 mA ESD performance: Human-body model > 2000V Machine model > 200V Charged-device model > 1000V Also packaged in plastic Fine-Pitch Ball Grid Array (FBGA) 	74LVT16374 • 74LVTH16374 Low Voltage 16-Bit D-Type Flip-Flop with	
Ordering Cod	le:			-Flo	
Order Number P	ackage Number		Package Description	- С	
74LVT16374G (Note 1)(Note 2)	BGA54A (Preliminary)		II Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide	vith	
74LVT16374MEA (Note 2)	MS48A		COutline Package (SSOP), JEDEC MO-118, 0.300" Wide	3-STATE	
74LVT16374MTD (Note 2)	MTD48		Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide	TAT	
74LVTH16374G (Note 1)(Note 2)	BGA54A	54-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide			
74LVTH16374MEA (Note 2)	MS48A		COutline Package (SSOP), JEDEC MO-118, 0.300" Wide	Outputs	
74LVTH16374MTD (Note 2)	MTD48	48-Lead Thin Shrink	Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide	uts	

Note 1: Ordering code "G" indicates Trays.

Note 2: Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

Logic Symbol



Connection Diagrams					
Pin Assignment for SSOP and TSSOP					
Pin Assignn $\overline{OE}_1 - O_0 -$	nent for SS 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	P		
	20 21 22 23 24	$ \begin{array}{c} 30 & -l_{12} \\ 29 & -l_{13} \\ 28 & -GND \\ 27 & -l_{14} \\ 26 & -l_{15} \\ 25 & -CP_2 \end{array} $			
Pin As	signment	for FBGA 4 5 6			
JHGFEDCBA					
(Top Thru \	/iew)			
Functional D		ian			

Functional Description

The LVT16374 and LVTH16374 consist of sixteen edge-triggered flip-flops with individual D-type inputs and 3-STATE true outputs. The device is byte controlled with each byte functioning identically, but independent of the other. The control pins can be shorted together to obtain full 16-bit operation. Each byte has a buffered clock and buffered Output Enable common to all flip-flops within that byte. The description which follows applies to each byte.

Pin Descriptions

Pin Names Description			
0E _n	Output Enable Input (Active LOW)		
CPn	Clock Pulse Input		
I ₀ —I ₁₅	Inputs		
O ₀ -O ₁₅	3-STATE Outputs		
0 ₀ –0 ₁₅ NC	No Connect		

FBGA Pin Assignments

	1	2	3	4	5	6
Α	O ₀	NC	OE ₁	CP1	NC	I ₀
В	0 ₂	0 ₁	NC	NC	I ₁	l ₂
С	O ₄	O ₃	V _{CC}	V _{CC}	l ₃	I ₄
D	O ₆	O ₅	GND	GND	I ₅	I ₆
E	0 ₈	0 ₇	GND	GND	۱ ₇	I ₈
F	O ₁₀	O ₉	GND	GND	l ₉	I ₁₀
G	O ₁₂	O ₁₁	V _{CC}	V _{CC}	I ₁₁	I ₁₂
Н	0 ₁₄	0 ₁₃	NC	NC	I ₁₃	I ₁₄
J	O ₁₅	NC	OE ₂	CP ₂	NC	I ₁₅

Truth Tables

	Inputs		Outputs
CP ₁		I ₀ —I ₇	0 ₀ –0 ₇
~	L	Н	н
~	L	L	L
L	L	х	O _o
х	н	х	z
	Inputs		Outputs
CP ₂	$\frac{\text{Inputs}}{\text{OE}_2}$	I ₈ —I ₁₅	Outputs O ₈ -O ₁₅
CP ₂	-	I ₈ –I ₁₅ Н	-
	0E2		0 ₈ –0 ₁₅
	0E2	Н	0 ₈ –0 ₁₅

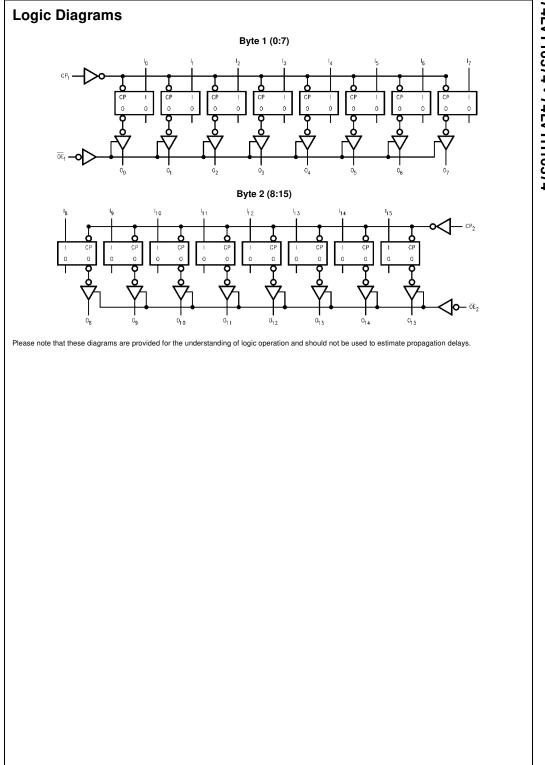
H = HIGH Voltage Level

L = LOW Voltage Level X = Immaterial

Z = HIGH Impedance

 $O_o = Previous O_o$ before HIGH to LOW of CP

Each flip-flop will store the state of their individual D-type inputs that meet the setup and hold time requirements on the LOW-to-HIGH Clock (CP_n) transition. With the Output Enable (\overline{OE}_n) LOW, the contents of the flip-flops are available at the outputs. When \overline{OE}_n is HIGH, the outputs go to the high impedance state. Operation of the \overline{OE}_n input does not affect the state of the flip-flops.



74LVT16374 • 74LVTH16374

Absolute Maximum Ratings(Note 3)

Symbol	Parameter	Value	Conditions	Units	
V _{CC}	Supply Voltage	-0.5 to +4.6		V	
V _I	DC Input Voltage	-0.5 to +7.0		V	
V _o	DC Output Voltage	-0.5 to +7.0	Output in 3-STATE	v	
		-0.5 to +7.0	Output in High or Low State (Note 4)	v	
IK	DC Input Diode Current	-50	V _I < GND	mA	
ОК	DC Output Diode Current	-50	V _O < GND	mA	
0	DC Output Current	64	V _O > V _{CC} Output at High State		
		128	V _O > V _{CC} Output at Low State	mA	
СС	DC Supply Current per Supply Pin	±64		mA	
GND	DC Ground Current per Ground Pin	±128		mA	
Г _{STG}	Storage Temperature	-65 to +150		°C	

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Units
V _{CC}	Supply Voltage	2.7	3.6	V
VI	Input Voltage	0	5.5	V
lон	High-Level Output Current		-32	mA
lol	Low-Level Output Current		64	mA
T _A	Free-Air Operating Temperature	-40	85	°C
∆t/∆V	Input Edge Rate, V _{IN} = 0.8V–2.0V, V _{CC} = 3.0V	0	10	ns/V

Note 3: Absolute Maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions is not implied. Note 4: I_O Absolute Maximum Rating must be observed.

DC Electrical Characteristics

Symbol	ol Parameter		V _{CC}	$T_A = -40^{\circ}C$	C to +85°C	Units	Conditions
Symbol			(V)	Min	Max	Units	Conditions
V _{IK}	Input Clamp Diode Voltage		2.7		-1.2	V	I _I = -18 mA
VIH	Input HIGH Voltage		2.7–3.6	2.0		V	$V_0 \le 0.1V$ or
VIL	Input LOW Voltage		2.7–3.6		0.8	v	$V_O \geq V_{CC} - 0.1V$
V _{OH}	Output HIGH Voltage		2.7–3.6	V _{CC} - 0.2			I _{OH} = -100 μA
			2.7	2.4		V	$I_{OH} = -8 \text{ mA}$
			3.0	2.0			I _{OH} = -32 mA
V _{OL}	Output LOW Voltage		2.7		0.2		I _{OL} = 100 μA
			2.7		0.5		I _{OL} = 24 mA
			3.0		0.4	V	$I_{OL} = 16 \text{ mA}$
			3.0		0.5		$I_{OL} = 32 \text{ mA}$
			3.0		0.55		$I_{OL} = 64 \text{ mA}$
I _{I(HOLD)}	Bushold Input Minimum Drive	n Drive		old Input Minimum Drive 3.0 75	μA	$V_I = 0.8V$	
(Note 5)			0.0	-75		μΑ	$V_I = 2.0V$
I _{I(OD)}	Bushold Input Over-Drive		3.0	500		μΑ	(Note 6)
(Note 5)	Current to Change State		0.0	-500			(Note 7)
I _I	Input Current		3.6		10		$V_I = 5.5V$
		Control Pins	3.6		±1	μA	$V_I = 0V \text{ or } V_{CC}$
		Data Pins	3.6		-5	<i>μ</i> .	$V_I = 0V$
		Bula Fillo	0.0		1		$V_I = V_{CC}$
I _{OFF}	Power Off Leakage Current		0		±100	μA	$0V \leq V_{I} \text{ or } V_{O} \leq 5.5V$
I _{PU/PD}	Power Up/Down 3-STATE		0–1.5V		±100	μA	V _O = 0.5V to 3.0V
	Output Current					•	$V_I = GND \text{ or } V_{CC}$
I _{OZL}	3-STATE Output Leakage Curre		3.6		-5	μA	$V_{O} = 0.5V$
I _{OZH}	3-STATE Output Leakage Curre		3.6		5	μA	$V_{O} = 3.0V$
I _{OZH} +	3-STATE Output Leakage Curre	nt	3.6		10	μA	$V_{CC} < V_O \le 5.5 V$

DC Electrical Characteristics (Continued)

Symbol	Parameter	V _{CC}	V_{CC} $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		$T_A = -40^{\circ}C$ to $+85^{\circ}C$		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions
Symbol	Falantee	(V)	Min	Min Max		Conditions				
ССН	Power Supply Current	3.6		0.19	mA	Outputs HIGH				
CCL	Power Supply Current	3.6		5	mA	Outputs LOW				
I _{CCZ}	Power Supply Current	3.6		0.19	mA	Outputs Disabled				
I _{CCZ+}	Power Supply Current	3.6		0.19	mA	$V_{CC} \leq V_O \leq 5.5V,$				
						Outputs Disabled				
Δl _{CC}	Increase in Power Supply Current	3.6		0.2	mA	One Input at V _{CC} – 0.6V				
	(Note 8)					Other Inputs at V _{CC} or GND				

Note 5: Applies to bushold versions only (74LVTH16374).

Note 6: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 7: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

Note 8: This is the increase in supply current for each input that is at the specified voltage level rather than V_{CC} or GND.

Dynamic Switching Characteristics (Note 9)

Symbol	Parameter	V_{CC} $T_{A} = 25 °C$		Units	Conditions		
Cymbol	i alamotor	(V)	Min	Тур	Мах	onno	$\textbf{C}_{\textbf{L}}=\textbf{50}~\textbf{pF},~\textbf{R}_{\textbf{L}}=\textbf{500}\Omega$
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}	3.3		0.8		V	(Note 10)
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	3.3		-0.8		V	(Note 10)

Note 9: Characterized in SSOP package. Guaranteed parameter, but not tested.

Note 10: Max number of outputs defined as (n). n-1 data inputs are driven 0V to 3V. Output under test held LOW.

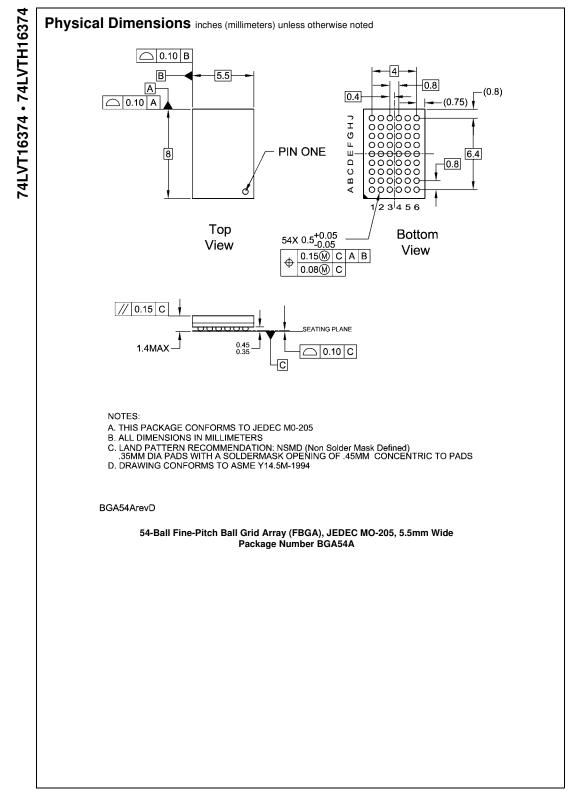
AC Electrical Characteristics

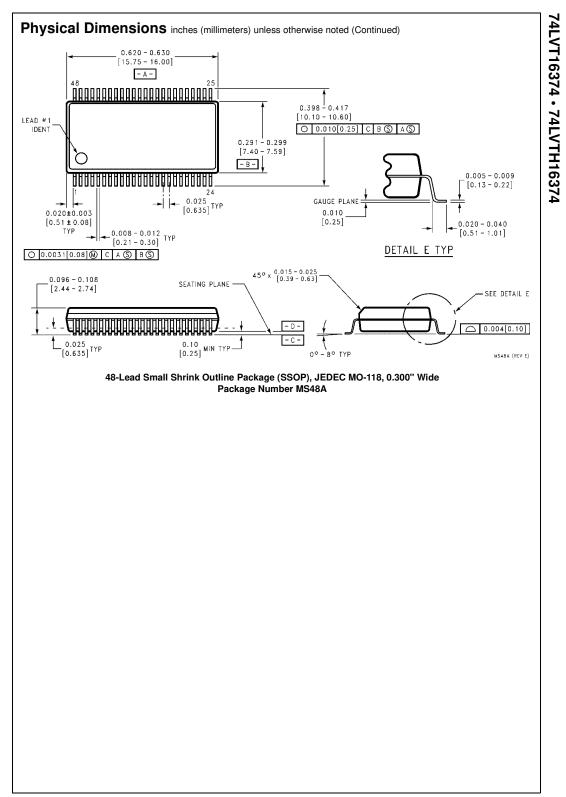
		T _A = -				
Symbol	Parameter	V _{CC} = 3.	V _{CC}	Units		
		Min	Max	Min	Max	
f _{MAX}	Maximum Clock Frequency	160		160		MHz
t _{PHL}	Propagation Delay	1.9	4.3	1.9	4.6	
t _{PLH}	CP to O _n	1.6	4.5	1.6	5.2	ns
t _{PZL}	Output Enable Time	1.3	4.4	1.3	5.0	
t _{PZH}		1.0	4.5	1.0	5.4	ns
t _{PLZ}	Output Disable Time	1.5	4.6	1.5	4.8	
t _{PHZ}		2.0	5.0	2.0	5.4	ns
t _S	Setup Time	1.8		2.0		ns
t _H	Hold Time	0.8		0.1		ns
t _W	Pulse Width	3.0		3.0		ns
t _{OSHL}	Output to Output Skew (Note 11)		1.0		1.0	
t _{OSLH}			1.0		1.0	ns

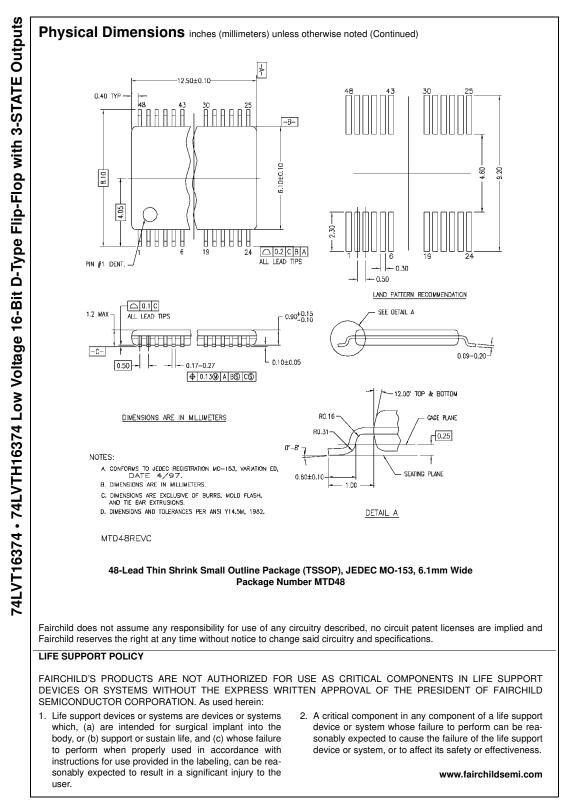
Note 11: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}).

Capacitance (Note 12)

Symbol	Parameter	Conditions	Typical	Units		
C _{IN}	Input Capacitance	$V_{CC} = Open, V_I = 0V \text{ or } V_{CC}$	4	pF		
C _{OUT}	Output Capacitance	$V_{CC} = 3.0V$, $V_O = 0V$ or V_{CC}	8	pF		
Note 12: Capacitance is measured at frequency f = 1 MHz, per MIL-STD-883, Method 3012.						







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